

Product Brief

TC358764/5 Display Bridge (MIPI® DSI to LVDS)

Highlights

- Display bridge for connectivity of LVDS panels to the Baseband or Application Processors with a Mobile Industry Processor Interface (MIPI) Display Serial Interface.
- Solutions are based on the latest versions of the industry-standard MIPI DSI 1.01 interface to ensure high-speed data rates of up to 800 Mbps per lane. It can be configured to support up to four DSI lanes.
- LVDS link transmitter supports maximum data bit rate of 297.5 MB per second for a single-link and 595 MB per second for a dual link.
- The TC358764 supports panels up to 1366 x 768, with 24 bits per pixel. The TC358765 supports panels up to 1920 x 1200, with 18 bits per pixel.
- Applicable to a range of mobile product platforms such as MIDs, netbooks, smartbooks and eBooks.

Description

The Toshiba TC358764/5 display bridge is optimized for mobile devices using a Host processor with MIPI DSI (Display Serial Interface) connectivity. The TC358764/5 functions as a protocol bridge enabling the video data stream from the Host processor DSI link to drive LVDS display panels. The TC358764/5 bridge can be configured to have up to a 4-lane MIPI DSI with data rates up to 800 Mbps per lane, for maximum total bandwidth of 3.2 Gbps. The TC358764 bridge has a single-link LVDS transmitter and can support up to a WXGA panel resolution (1366 x 768, 24-bit/pixel). The TC358765 bridge has a dual-link LVDS transmitter and can support up to WUXGA panel resolution (1920 x 1200, 18-bit/pixel). A video line buffer is used to buffer the burst video data received from the DSI link before transmitting out from the LVDS link.

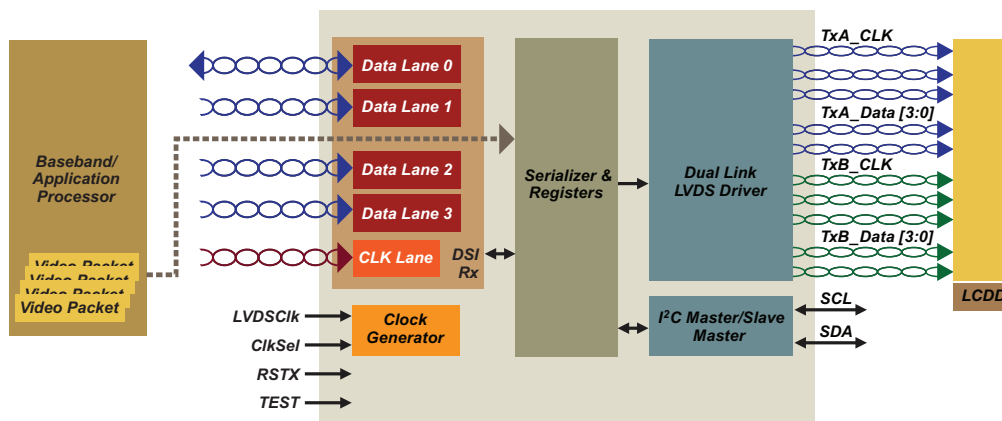
The TC358764XBG is a 49-pin device and the TC358765XBG is a 64-pin device with 0.65mm ball pitch suitable for lower cost printed circuit boards.

The Toshiba proprietary Magic Square algorithm can interpolate RGB666 to pseudo RGB888 image data to display up to 16 million colors.

Features

- MIPI standard implemented
 - MIPI DSI version 1.01, Feb 2008
 - MIPI D-PHY version 0.9, Oct 2007
 - MIPI DCS version 1.02, Dec 2008
- DSI Receiver
 - MIPI DSI-RX Data 4-lane, CLK 1-lane with data rates up to 800 Mbps/lane
 - Video input frame sizes: Up to WXGA (1366 x 768, 24-bit/pixel) on single-link LVDS; Up to WUXGA (1920 x 1200, 18-bit/pixel) on dual-link LVDS
 - Video input data formats: RGB888, RGB666 and RGB565
- LVDS Transmitter
 - Supports single-link or dual-link LVDS
 - Maximum pixel clock frequency of 85 MHz
 - Maximum per data channel bit rate of 595 Mbits per second
 - Maximum data throughput of 297.5 MBytes per second for single-link and 595 MBytes per second for dual-link
 - Supports the following pixel formats:
 - RGB666 18 bits per pixel
 - RGB666 loosely packed 18 bits per pixel
 - RGB565 16 bits per pixel
 - RGB565 loosely packed 16 bits per pixel
 - RGB888 24 bits per pixel

System Block Diagram of TC358765XBG



Product Brief

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- Peripheral control ports
 - I²C Master/Slave ports with data rates up to 400 KHz. External I²C master can access TC358764/5 internal registers via this port.
- Clock Source
 - External reference clock needed to generate internal LVDS pixel clock
 - Built-in PLL is used to generate the high-speed LVDS serializing clock
- Power supply
 - CORE: 1.2 \pm 0.1V
 - MIPI DSI D-PHY: 1.2 \pm 0.1V
 - LVDS PHY: 3.3V \pm 0.3V
 - I/O : 1.8 \pm 0.1V to 3.3 \pm 0.3V
- Package
 - TC358765: P-TFBGA 64-pin, 6 mm x 6 mm, 1.2 mm height, 0.65 mm ball pitch
 - TC358764: P-TFBGA 49-pin, 5 mm x 5 mm, 1.2 mm height, 0.65 mm ball pitch

Toshiba Mobile Initiative

This chipset is a member of the Toshiba mobile initiative product family. The Toshiba Mobile Strategic Initiative is a comprehensive program designed to offer its U.S.-based mobile handset/mobile consumer device customers a product portfolio that aims to provide faster time-to-market and helps them stay competitive.

As part of this initiative, Toshiba provides local application and design-in support and access to a host of analog peripheral ICs, including the Toshiba CMOS image sensor family, display controllers/drivers, I/O expander, bridge ICs, memory products and LCD modules.

The expanded portfolio also includes support tools, reference designs and evaluation boards

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